



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 09/964,484 Confirmation No. 2783
Applicant : T. ISHIDA et al
Filed : September 28, 2001
Title : A SEMICONDUCTOR DEVICE HAVING STACKED
SEMICONDUCTOR CHIPS SEALED WITH A
RESIN SEAL MEMBER (As Amended)
TC/AU : 2826
Examiner : A.O. Williams
Docket No. : H-1013
Customer No.: 24956

Commissioner for Patents
Mail Stop AF
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action (Final Rejection) of July 13, 2005, please amend the above-identified application as follows. A Petition and fee for a three-month Extension of Time also accompanies this response.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks / Arguments begin on page 5 of this paper.